IBIS-ATM task group report

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Achievements since DesignCon 2015

- **IBIS v6.1 has been released on September 11, 2015 including the following 13 BIRDs:**

  - **BIRD155.2**   **New AMI API to Resolve Dependent Model Parameter**
  - **BIRD167.1**   **Table Corrections for Tx Jitter Parameters and Ignore_Bits**
  - **BIRD168.1**   **Handling of Overclocking Caused by Delay in Waveform Tables**
  - **BIRD169.1**   **DLL Dependency Checking**
  - **BIRD170**   **Delete Extra Paragraph for Ports under [External Circuit]**
  - **BIRD171.3**   **Clarify that Empty Root Name is Not Permitted in AMI Files**
  - **BIRD172.2**   **Extend Multilingual Parameter and Converter Parameter Rules**
  - **BIRD173.3**   **Package RLC Matrix Diagonals**
  - **BIRD174.1**   **Quote Character Clarifications**
  - **BIRD175.3**   **Extending IBIS-AMI for PAM4 Analysis**
  - **BIRD176**   **Power Pin Package Modeling**
  - **BIRD177**   **[Initial Delay] keyword for Submodels and Driver Schedules**
  - **BIRD178.3**   **Specifying Buffer Directionality for AMI**

- **One BIRD was approved since the release of IBIS v6.1:**
  - **BIRD 179**   **New IBIS-AMI Reserved Parameter Special_Param_Names**

Pending BIRDs

- **125.1**   **Make IBIS-ISS Available for IBIS Package Modeling**
- **128.2**   **Allow AMI_parameters_out to pass AMI_parameters_in data on calls to AMI_GetWave**
- **145.3**   **Cascading IBIS I/O buffers with [External Circuit]s using the [Model Call] keyword**
- **147**   **Back-channel support**
- **158.3**   **AMI Touchstonefile (R) Analog Buffer Models**
- **161.1**   **Supporting Incomplete and Buffer-only [Component] Descriptions**
- **163**   **Instantiating and Connecting [External Circuit] Package Models with [Circuit Call]**
- **164**   **Allowing Package Models to be defined in [External Circuit]**
- **165**   **Parameter Passing Improvements for [External Circuit]s**
- **166**   **Resolving problems with Redriver Init Flow**
- **TBD**   **New Back-channel/Co-optimization**
- **TBD**   **New interconnect BIRD**
- **TBD**   **C_comp modeling with IBIS-ISS**

**Most of these BIRDs are "tabled" because of their
dependence on other BIRDs or proposals**

BIRDs and proposals grouped by topics

- **The IBIS Interconnect Task Group is working on a proposal which will most likely supersede the following four BIRDs:**
  - BIRD 125.1   Make IBIS-ISS Available for Package Modeling
  - BIRD 145.3   Cascading IBIS I/O buffers with [External Circuit]s
  - BIRD 163   Instantiating and Connecting [External Circuit] Package Models with [Circuit Call]
  - BIRD 164   Allowing Package Models to be defined in [External Circuit]

- **There are two AMI related BIRDs which need to be finished:**
  - BIRD 158.3   AMI Touchstonefile (R) Analog Buffer Models
  - BIRD 166   Resolving problems with Redriver Init Flow

- **The Backchannel communication and channel optimization BIRDs are still awaiting a resolution:**
  - BIRD 128   Allow AMI_parameters_out to pass input data to AMI_GetWave
  - BIRD 147   Back-channel support

- **Miscellaneous BIRDs:**
  - BIRD 161.1   Supporting Incomplete and Buffer-only [Component] Descriptions
  - BIRD 165   Parameter Passing Improvements for [External Circuit]s

- **The "C_comp modeling with IBIS-ISS" proposal is on hold due to a strong overlap with the package and on-die interconnect proposal**

- **Started a major effort to clean up the "GND language" in the specification**